

RoHS

COMPLIANT

N-Channel 45 V (D-S) Super Junction MOSFET

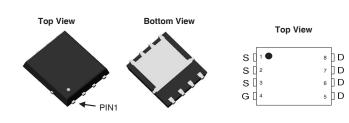
PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (mΩ)(Typ.)	I _D (A) ^{a,e}	Q _g (Typ.)			
45	5.8 at V _{GS} = 10 V	60	12.8 nC			
	7.7 at V _{GS} = 4.5 V	00				

FEATURES

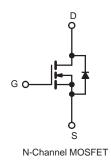
- DT-SJ Power MOSFET
- Low R_{DS(ON)}×FOM
- Extremely low switching loss
- · Fast switching and soft recovery

APPLICATIONS

- Motor driver
- Switching voltage regulator
- DC-DC convertor



DFN5X6-8L Pin Configuration



ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unle Parameter		Symbol Limit		Unit	
			Unit		
Drain-Source Voltage	V _{DS}	45	V		
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	1	60		
	T _C = 100 °C	I _D	42	А	
Pulsed Drain Current (t = 300 µs)		I _{DM}	240		
Single Pulse Avalanche Energy	L = 0.5 mH	E _{AS}	250	mJ	
	T _C = 25 °C		56		
Maximum Power Dissipation	T _C = 100 °C	PD	36	w	
Maximum Power Dissipation	T _A = 25 °C	' D	3.9 ^{b, c}	~ ~ ~	
	T _A = 100 °C		2.5 ^{b, c}		
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 150	°C		
Soldering Recommendations (Peak Temperatur		260			

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R _{thJA}	-	35	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	-	2.2	0/11	

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. The DFN5X6 is a leadless package. The end of the lead terminal is exposed copper

(not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 70 °C/W.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$	45			V	
Gate-Source Threshold Voltage	VGS(th)	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 45 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = 36 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			1	μA	
Zero Gale volage Drain Gurrent					10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	60			Α	
	Page	V _{GS} = 10 V, I _D = 20 A		5.8	7.2		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 10 A		7.7	10	mΩ	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		75		S	
Dynamic ^b							
Input Capacitance	C _{iss}			812		pF	
Output Capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		309			
Reverse Transfer Capacitance	C _{rss}	1		4.5			
Total Gate Charge ^c	Qg			12.8			
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		1.7		nC	
Gate-Drain Charge ^c	Q _{gd}			2			
Gate Resistance	Rg	f = 1 MHz		3.5		Ω	
Turn-On Delay Time ^c	t _{d(on)}			23			
Rise Time ^c	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 0.5 \Omega$		10		- ns	
Turn-Off DelayTime ^c	t _{d(off)}	$I_D \cong 20$ Å, $V_{GEN} = 10$ V, R $_g = 1$ Ω		65			
Fall Time ^c	t _f	1		10		1	
Drain-Source Body Diode Characterist	ics				1		
Continous Source-Drain Diode Current	۱ _S	T _C = 25 °C			60	^	
Pulse Diode Forward Current (100 µs)	I _{SM}				240	A	
Body Diode Voltage	V _{SD}	I _S = 1 A			1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			43		ns	
Body Diode Reverse Recovery Charge	Q _{rr}			58		nC	
Reverse Recovery Fall Time	t _a	$I_F = 20 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		20			
Reverse Recovery Rise Time	t _b	\neg		19		ns	

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%.$

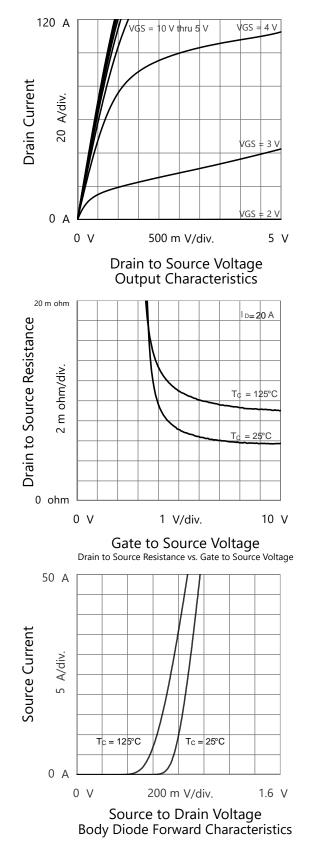
b. Guaranteed by design, not subject to production testing.

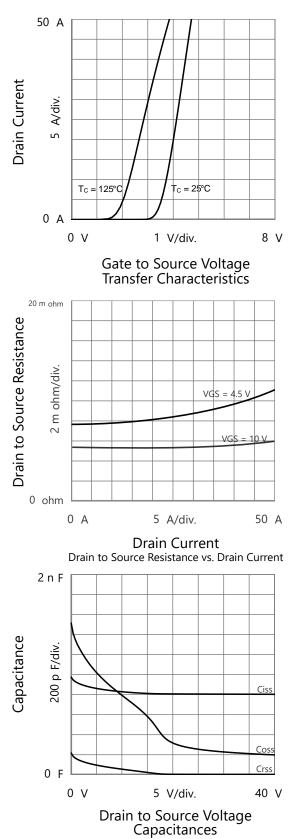
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



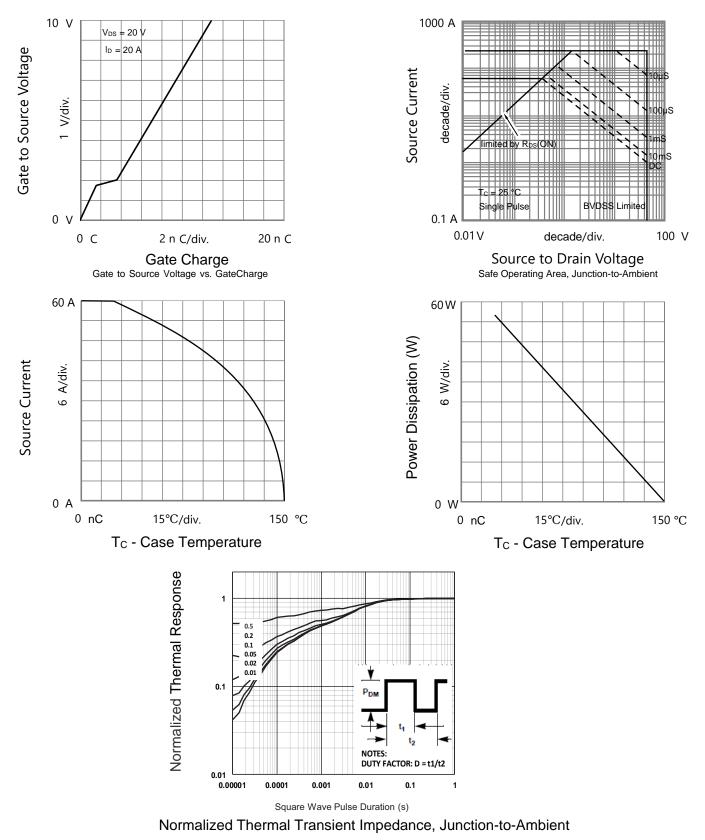




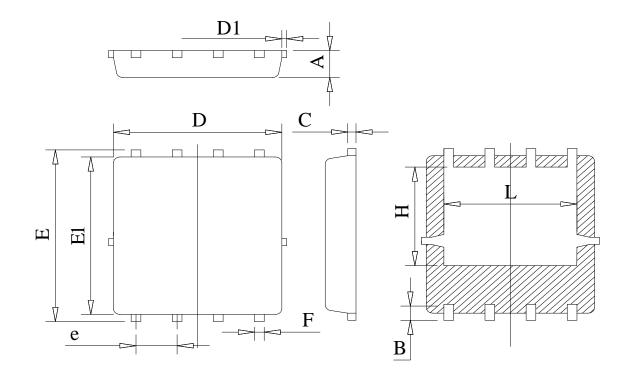








DFN5*6-8L PACKAGE OUTLINE



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

Symbol	Min	Тур	Max
А	0.78	0.95	1.12
В	0.45	0.58	0.78
С	0.18	0.254	0.36
D	4.70	5.20	5.45
D1			0.18
Е	5.85	6.05	6.25
E1	5.38	5.55	5.98
e	1.15	1.27	1.40
F	0.18	0.30	0.52
Н	3.25	3.47	3.70
L	3.75	4.00	4.25



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